2178710-8 SUPERSEDED

Micro-MaTch | Micro-MaTch Value Line

TE Internal #: 2178710-8

TE Internal Description: 8P, FOB, THT, MICRO-MATCH VALUE

LINE

FEMALE-ON-BOARD CON TOP ENTRY VALUE-LINE

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > Ribbon Cable Connectors > FEMALE-ON-BOARD CON TOP ENTRY VALUE-LINE



Connector System: Board-to-Board

Number of Positions: 8

Centerline (Pitch): 1.27 mm [.05 in]

PCB Mount Retention: With

PCB Mount Retention Type: Kinked Solder Tails

All FEMALE-ON-BOARD CON TOP ENTRY VALUE-LINE (1)

Features

Product Type Features

Connector Type	Connector Assembly
Ribbon Cable Connector Type	Female-on-Board
Ribbon Cable Connector Header Type	Shrouded
Connector Product Type	Connector Assembly
Connector System	Board-to-Board
Connector & Housing Type	Receptacle
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Number of Positions	8
PCB Mount Orientation	Vertical

Electrical Characteristics

Insulation Resistance	1000 ΜΩ
Operating Voltage	100 VAC

Body Features

Daisy Chain	Without
Connector Profile	Standard



Contact Features

PCB Contact Termination Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Type	Socket
Contact Mating Area Plating Material Thickness	3 – 5 μm[118.11 – 196.85 μin]
Contact Mating Area Plating Material	Tin
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.85 A

Termination Features

Rectangular Termination Post & Tail Thickness	.25 mm[.01 in]
Rectangular Termination Post & Tail Width	.5 mm[.02 in]
Termination Post & Tail Length	3.1 mm[.122 in]
Termination Method to Printed Circuit Board	Through Hole - Solder

Mechanical Attachment

Mating Alignment	Without
Contact Retention Type Within Housing	Press-Fit
PCB Mount Alignment	Without
Panel Mount Feature	Without
PCB Mount Retention	With
PCB Mount Retention Type	Kinked Solder Tails
Mating Retention	Without
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Тор
Housing Material	Polyester GF
Housing Color	Black
Centerline (Pitch)	1.27 mm[.05 in]

Dimensions

Connector Length	12.2 mm[.48 in]
Connector Height	4 mm[.16 in]



PCB Thickness (Recommended)	1.6 mm[.062 in]
Row-to-Row Spacing	1.5 mm
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-30 - 85 °C[-22 - 185 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Industry Standards	
UL Rating	Recognized
Agency/Standard	UL
UL File Number	E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	2500

Product Compliance

Packaging Method

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2020 (205) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Reel

Product Compliance Disclaimer

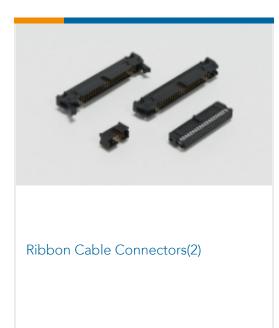
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these



limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

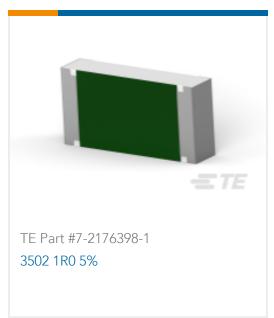
Also in the Series | Micro-MaTch Value Line





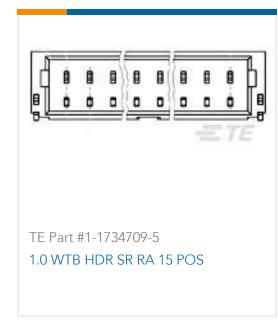
Customers Also Bought

















Documents

CAD Files

3D PDF

3D

Customer View Model

ENG_CVM_CVM_2178710-8_A.2d_dxf.zip

English

Customer View Model



ENG_CVM_CVM_2178710-8_A.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2178710-8_A.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

1-1773840-5_MICRO-MATCH-VALUE-LINE-QRG

English

Product Specifications

Product Specification

English